

Sheet 1 of 1								Atty. Docket No. 4172		Serial No.: 10/016,495				
LIST OF REFERENCES CITED BY APPLICANT (REVISED FORM PTO-1449) DATED: January 30, 2002								Applicant: Klaus SAUTER et al.						
								U.S. Filing Date: October 30, 2001		Art Unit: 2811				
U. S. PATENT DOCUMENTS														
*EXAMINER INITIAL		DOCUMENT NO.							DATE	NAME	Cl.	Sub- Cl.	Fil. Date	
		AA	4	2	9	5	1	1						7
TT	AA	4	2	9	5	1	1	7	10/1981	Lake et al.	-	-	-	
TT	AB	4	5	4	5	8	4	0	10/1985	Newman et al.	-	-	-	
FOREIGN PATENT DOCUMENTS														
		DOCUMENT NO.							DATE	COUNTRY	Cl.	Sub- Cl.	Trans.	
		AC	2	7	5	6	5	0					0	06/1979
TT	AC	2	7	5	6	5	0	0	06/1979	Fed. Rep. of Germany	-	-		x
TT	AD	60	2	5	3	2	8	0	12/1985	Japan (English Abstract)	-	-	x	Abst.
TT	AE	G9	1	1	6	2	0	6	05/1992	Germany (Utility Model)	-	-		x
TT	AF	WO 97	/	2	2	9	9	3	06/1997	PCT	-	-	x	
OTHER DOCUMENTS														
TT	AG	IBM Technical Disclosure Bulletin, "Chip-Heatsink Attach Using Contoured Adhesive With Glass Stand-Offs"; IBM Technical Disclosure Bulletin, Vol. 34, No. 3; August 1, 1991; IBM Corporation, New York, pg. 161, 162.												
EXAMINER		Thien VM							DATE CONSIDERED		06-13-03			
<p>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>														